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ISSUE

Jun-27-08

ELECTRONIC COMPONENTS AND DEVICES GROUP

SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR LIGHT EMITTING DIODE MODULE

MODEL No.

GW5BWF15L00

Specified for

Reference

CUSTOMERS' APPROVAL

Date

By

PRESENTED

Date June, 27, 2008

By

Y.Inada, V Department General Manager A1249 Project Team ELECTRONIC COMPONENTS AND DEVICES GROUP SHARP CORPORATION

PRODUCT NAMELight Emitting Diode ModuleMODEL No.GW5BWF15L00



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GW5BWF15L00 specificat	ion	
 Application This specification applies to the light emitting diode module Model [White (from InGaN Blue LED chip + Phosphor) LED module] Main use : Illumination 	No. GW5BWF15L00	
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× This specification is reference.		





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3. Ratings and characteristics

3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power dissipation *1	Р	8.0	W
Forward current *1	$I_{\rm F}$	700	mA
Reverse Voltage	V _R	-15	V
Operating temperature *2	Topr	-30~+90	°C
Storage temperature	Tstg	-40∼+100°C	°C

*1 Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

*2 Operating temperature is fixed to the temperature of module's external part.

(Not an ambient temperature)

The derating curve in the next page is applied to the operating current.

3-2. Electro-optical characteristics

					Tc	=25 °C
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward voltage	V _F	IF=640mA	8.5	(10.2)	11.5	V
Luminous Flux *3	φ	IF=640mA	400	(540)	-	lm
Chromaticity	X	IF=640mA	-	0.345	-	
*4	у		-	0.351	-	
	Tc		(4700)	5000	(5300)	Κ

) is reference. * (

(*3) Monitored by 8 inch integrating sphere of Sharp Standards. (After 20 ms drive) (Tolerance: $\pm 15\%$)

(*4) Monitored by 8 inch integrating sphere of Sharp Standards Measured by Otsuka electronics MODEL LE-3400 (After 20 ms drive) (Tolerance: x, y: ± 0.02)





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4. Reliability

The reliability of products shall be satisfied with items listed below.

4-]	I. Test items and test c	onditions	Confide	nce level	: 90%
No.	Test items	Test conditions	Samples	Defective	LTPD
			n	С	(%)
1	Temperature	-40 °C(30 min)~+100 °C(30 min), 30 times			
	cycle		11	0	20
2	High temp and high	Ta*=+60°C, RH=90%, t=1,000h			
	humidity storage		11	0	20
3	High temperature	$Ta^{*}=+100^{\circ}C, t=1,000h$			
	storage		11	0	20
4	Low temperature	Ta*= -40 °C, t=1000h			
	storage		11	0	20
5	Operating test	Tc=60 °C, IF=640mA, t=1,000h			
			11	0	20
6	Mechanical shock	$15,000 \text{ m/s}^2, 0.5 \text{ ms}$			
	test	$\pm X \cdot \pm Y \cdot \pm Z$ direction, 3 times	5	0	50
7	Variable frequency	200 m/s^2 , $100 \sim 2,000 \sim 100 \text{ Hz}$ / sweep for 4 min.			
	vibration	$X \cdot Y \cdot Z$ direction, 4 times	5	0	50

4-2. Failure judgment criteria

No.	Parameter	Symbol	Failure judgment criteria (*2)
1	Forward voltage	V _F	$V_F > U.S.L \times 1.1$
2	Luminous flux	Φ	$\Phi \le$ Initial value × 0.5, $\Phi \ge$ Initial value × 2.0

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5. Incoming inspection		
5-1. Inspection method		

A single sampling plan, normal inspection S-4 based on ISO 2859-1 shall be adopted.

5-2. Description of inspection and criteria

No.	Inspection items	Criteria	Defect	AQL
1	Emission	No emission	Major defect	0.1%
2	Electro-optical characteristics Outline	Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity) Not conforming to the specification	Minor	0.4%
	dimensions	(Outline dimensions of (1), (2) in page3)	defect	
4	Appearance	determined as good product except that electro-optical characteristics is affected by.		

*Products with removable foreign material attached on is not determined to be defective.



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7. Precautions

- ① Storage conditions
 - Please follow the conditions below.
 - •Before opened : Temperature 5 \sim 30°C, humidity less than 60%RH
 - •After opened : Temperature $5 \sim 30^{\circ}$ C, humidity less than 60%RH (Please apply soldering within 1 week.)
 - •Avoid exposing to air with corrosive gas.

If exposed, electrode surface would be damaged, which may affect soldering.

② Usage conditions

The products are not designed for the use under any of the following conditions.

- Please confirm their performance and reliability well enough if you use under any of the following conditions;
- In a place with a lot of moisture, dew condensation, briny air, and corrosive gas (Cl, H₂S, NH₃, SO₂, NO_X, etc.).
- •Under the direct sunlight, outdoor exposure, and in a dusty place.
- ·In water, oil, medical fluid, and organic solvent.
- ③ Heat radiation

If the forward current(IF) is applied to single-state module at 360mA, there is a risk of damaging module or emitting smoke.

Equip with specified heat radiator, and avoid heat stuffed inside the module.

Applying thermal conductive sheet or grease between module and heat radiator enables heat to radiate effectively.

4 Installation

Material of board is alumina ceramic. If installed inappropriately, trouble of no radiation may occur due to board crack. Please take particular notice of install method.

Further information on installation, refer to the following cautions.

• Apply ether screws or adhesives, or both of them when installed to heat radiator.

In case of applying adhesive only, check the effectiveness before fixing.

In case of screw, apply thread locker in order to prevent loosening.

If LED comes off from the heat radiator, unusual temperature rise entails hazardous phenomena including device deterioration, coming off of solder at leads, and emitting smoke.

Refer to recommended dimensions when installing with screws.



• Screw torque: Within 0.2Nm

If it is inefficient to tighten screws, apply locker to prevent loosening.

• It is recommended to apply screws which use low corrosive materials such as Stainless steel.

Avoid applying flat-head screws, which cause board crack due to applying stress to screw holes. Avoid convexly uneven boards.

- Those convex boards are subject to crack when tightening screws.
- It is recommended to apply thermal conductive sheet or grease with adhesiveness and heat radiatingadhesives, because of thermal and mechanical combination between module and heat radiator.
 However, depending on their thickness, board crack may be entailed by warped board, which is caused when tightening screws. So please check your actual conditions carefully as for the screw torque.

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4	RP	
5) Module surface strength	
	Module surface is subject to mechanical stress. Applying stress to surface of modules result and inside-failure.	s in damage on
6) Connecting method	
	In case of solder connecting method, apply solder to the leads	
	by soldering iron with thermo controller (tip temperature 380°C), within 10seconds per one	e place.
	Put the board on materials whose conductivity is poor enough not to radiate heat of solderin	ıg.
	Avoid touching yellow phosphor with soldering iron.	
	This product is not designed for reflow and flow soldering.	
\bigcirc) Static electricity	
	This product is subject to static electricity, so take measures to cope with it.	
	Install circuit protection device to drive circuit, if necessary.	
8) Drive method	
	Module is composed of LEDs connected in both series and parallel. Constant voltage power	r supply
	runs off more than specified current amount due to lowered VF caused by temperature rise.	
	Constant current power supply is recommended to drive.	
	Any reverse voltage cannot be applied to LEDs when they are in operation or not.	
	Design a circuit so that any flow of reverse or forward voltage can not be applied to LEDs v	when they are
_	out of operation.	
9) Cleaning	
	Avoid cleaning, since silicone resin is eroded by it.	
(10)) Color-tone variation	
	Chromaticity of this product is monitored by integrating sphere right after the operation.	
	Chromaticity varies depending on measuring method, light spread condition, or ambient ten	nperature.
(1)	Please verify your actual conditions before use.	
Û) Safety	
	Looking directly at LEDs for a long time may result in nur your eyes.	1 line abnor
	In case that excess current(over ratings) are supplied to the device, hazardous phenomena in	icluding autori
	heat generation, emitting smoke, or caucing file can be caused.	
	Take appropriate measures to excess current and vonage.	
	In case of solder connecting method, there is a possibility of large familie by heat.	1 hor contact
	Please application devices	1 by contact.
	Please confirm the safety standards of regulations of appreadon devices.	